



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Nguyen

Application No.: 09/747,703

Filed: December 21, 2000

Title: METHOD AND APPARATUS FOR  
REDUCING He BACKSIDE FAULTS  
DURING WAFER PROCESSING

Attorney Docket No.:  
LAM1P155/P0700

Examiner: Kornakov, Michail

Group: 1746

Confirmation No.: 9960

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on July 8, 2003 in an envelope addressed to the Commissioner of Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: \_\_\_\_\_

Agnes Spente

**RESPONSE D**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Advisory Action dated June 5, 2003 please enter the following amendments and remarks.

The pending Claims are reflected in the **Listing of Claims** which begins on page 2 of this paper.

**Remarks** begin on page 7 of this paper.